

DISTRIBUTED FEEDBACK LASER

GaAs Semiconductor Laser Diode
with integrated grating structure

0.90

03.12.2007

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PRELIMINARY SPECIFICATION

DFB Laser

EYP-DFB-0773-00075-1500-TOC03-0000

General Product Information

Product	Application
773 nm DFB Laser with TO Housing	Spectroscopy
Monitor Diode, Thermoelectric Cooler and Thermistor	Metrology

Absolute Maximum Ratings

	Symbol	Unit	min	typ	max
Storage Temperature	T_S	°C	-40		85
Operational Temperature at Case	T_C	°C	-20		75
Forward Current	I_F	mA			180
Reverse Voltage	V_R	V			0
Output Power	P_{opt}	mW			90

Recommended Operational Conditions

	Symbol	Unit	min	typ	max
Temperature at Laser Chip	T_{LD}	°C	15		40
Forward Current	I_F	mA			140
Output Power	P_{opt}	mW	10		75

Characteristics at $T_{amb} 25\text{ °C}$ at Begin Of Life

Parameter	Symbol	Unit	min	typ	max
Center Wavelength	λ_c	nm	772	773	774
Spectral Width (FWHM)	$\Delta\lambda$	MHz		2	10
Temperature Coefficient of Wavelength	$d\lambda / dT$	nm / K		0.06	
Temperature Coefficient of Current	dI_F / dT	mA / K		0.003	
Output Power @ $I_F = 140\text{ mA}$	P_{opt}	mW	75		
Slope Efficiency	S	W / A	0.6	0.8	1.0



Stress in excess of the Absolute Maximum Ratings can cause permanent damage to the device. Operation at the Absolute Maximum Rating for extended periods of time can adversely affect the device reliability and may lead to reduced operational life.

measured by thermistor

total output measured with integrated sphere

Measurement Conditions / Comments

see images on page 4

total output measured with integrated sphere

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RWE/RWL



BAL



DFB/DBR



TPL/TPA

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Characteristics at T_{amb} 25 °C at Begin Of Life

Parameter	Symbol	Unit	min	typ	max
Threshold Current	I_{th}	mA			70
Operational Current @ $P_{opt} = 75$ mW	I_{op}	mA			140
Sidemode Supression Ratio	SMSR	dB	30	45	
Cavity Length	L	μ m		1500	
Divergence parallel	$\Theta_{ }$	°	6	8	10
Divergence perpendicular	Θ_{\perp}	°	18	21	24
Polarization				TM	
Spatial Mode (transversal)				TEM ₀₀	
Spectral Mode (longitudinal)				Single Mode	

Measurement Conditions / Comments

$P_{opt} = 50$ mW

E field parallel to long axis of housing
fundamental mode

Monitor Diode

Parameter	Symbol	Unit	min	typ	max
Monitor Detector Responsivity	I_{mon} / P_{opt}	μ A / mW	0.5		5
Reverse Voltage Monitor Diode	U_{RMD}	V	3		5
Monitor Linearity	Lin_{MD}	%	-10		+10

Measurement Conditions / Comments

$U_R = 5$ V, target values

$P_{opt} = 10 \dots 75$ mW, $U_R = 5$ V

Thermoelectric Cooler

	Symbol	Unit	min	typ	max
Current	I	A			1.8
Voltage	U	V			3.2
Thermal Load	Q_c	W			3.1
Temperature Difference	dT	K			50

$T_{chip} = 25^{\circ}\text{C}$; $P_{opt} = 75$ mW

Thermistor (Standard NTC Type)

	Symbol	Unit	min	typ	max
Resistance	R	kOhm		10	
Beta Coefficient	β			3892	

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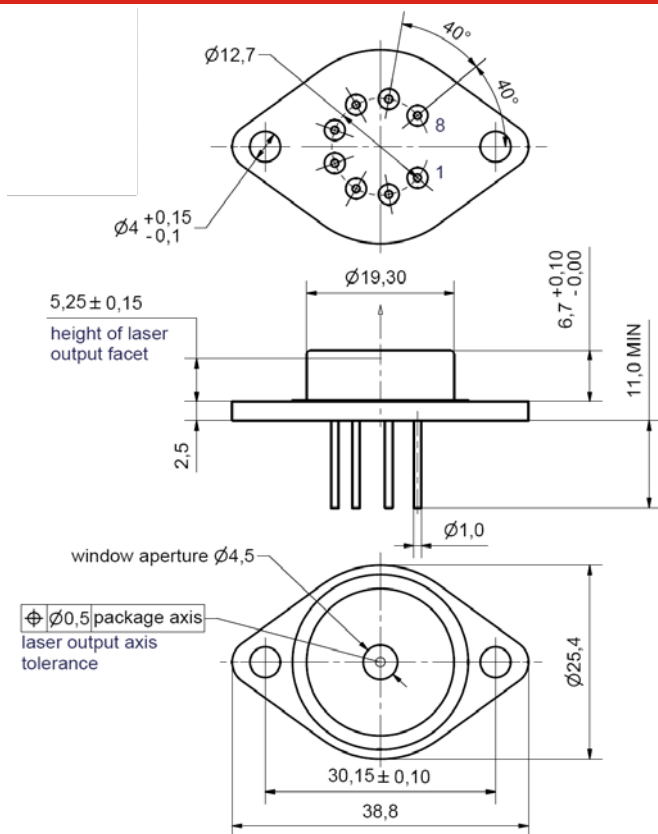
Package Dimensions

	Symbol	Unit	min	typ	max
Height of Laser Output above Header	H_L	mm		5.0	
Housing Dimension	$l \times w \times h$	mm ³		38.8 x 25.4 x 9.2	
Pin Length	L	mm	11.0		

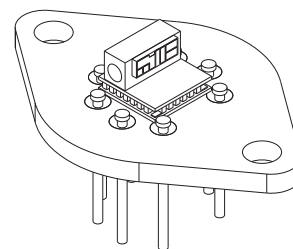
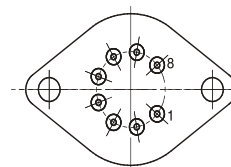
Package Pinout

1	Thermoelectric Cooler (+)	5	Laser Diode (Anode)
2	Thermistor	6	Photo Diode (Anode)
3	Thermistor	7	Photo Diode (Cathode)
4	Laser Diode (Cathode)	8	Thermoelectric Cooler (-)

Package Drawings



bottom view



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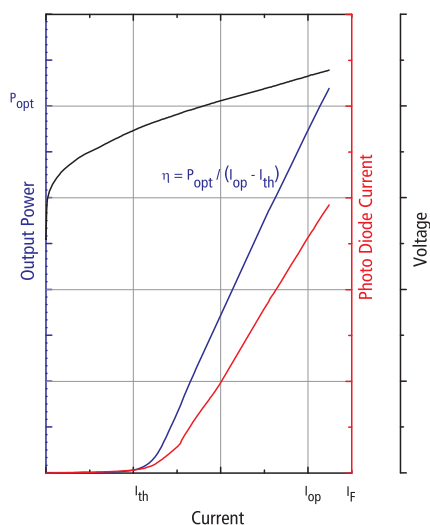
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DFB Laser

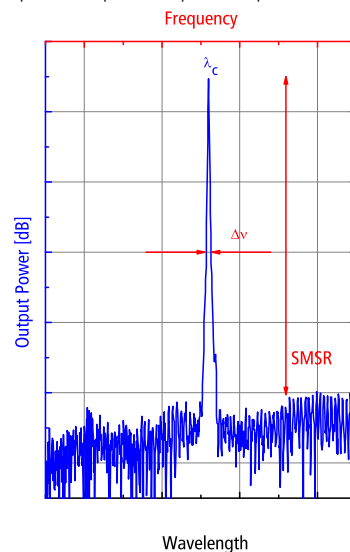
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Typical Measurement Results

Output Power vs. Current



Spectra at Specified Optical Output Power



Performance figures, data and any illustrative material provided in this specification are typical and must be specifically confirmed in writing by eagleyard Photonics before they become applicable to any particular order or contract. In accordance with the eagleyard Photonics policy of continuous improvement specifications may change without notice.

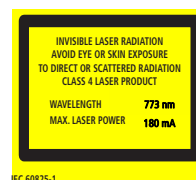
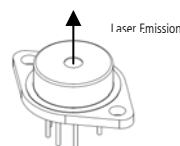
Unpacking, Installation and Laser Safety

Unpacking the laser diodes should only be done at electrostatic safe workstations (EPA). Though protection against electro static discharge (ESD) is implemented in the laser package, charges may occur at surfaces. Please store this product in its original package at a dry, clean place until final use. During device installation, ESD protection has to be maintained.

The DFB diode type is known to be sensitive against optical feedback, so an optical isolator may be required in some cases. Operating at moderate temperatures on proper heat sinks will contribute to a long lifetime of the diode.

The laser emission from this diode is close to the invisible infrared region of the electromagnetic spectrum. Avoid direct and/or indirect exposure to the free running beam. Collimating the free running beam with optics as common in optical instruments will increase threat to the human eye.

Each laser diode will come with an individual test protocol verifying the parameters given in this document.



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